

**AMENDMENTS TO THE CLAIMS**

**This listing of claims will replace all prior versions and listings of claims in the application:**

**LISTING OF CLAIMS:**

**1. (currently amended):** A pressure-sensitive adhesive tape or sheet having a pressure-sensitive adhesive layer formed on at least one surface of the support thereof, wherein the surface of the pressure-sensitive adhesive layer on at least one surface of the support partly has projected spots of fibers and said surface having the projected spots of fibers is protected with a releasable liner that has recesses at the sites of the surface thereof corresponding to the projected spots of fibers of the pressure-sensitive adhesive layer.

**2. (original):** The pressure-sensitive adhesive tape or sheet as claimed in claim 1, wherein the projected spots of fibers are raised spots of fibers that are raised from the surface of the pressure-sensitive adhesive layer.

**3. (canceled).**

**4. (currently amended):** The pressure-sensitive adhesive tape or sheet as claimed in claim 31, wherein the recesses of the releasable liner are perforations.

**5. (original):** The pressure-sensitive adhesive tape or sheet as claimed in claim 1, wherein the projected spots of fibers of the surface of the pressure-sensitive adhesive layer are provided to

have a predetermined pattern as a whole.

**6. (original):** The pressure-sensitive adhesive tape or sheet as claimed in claim 1, wherein the support is a substrate for pressure-sensitive adhesive tape or sheet, the pressure-sensitive adhesive layer is formed on both surfaces of the substrate, and the projected spots of fibers are formed in the surface of the pressure-sensitive adhesive layer on one surface of the substrate.

**7. (original):** The pressure-sensitive adhesive tape or sheet as claimed in claim 1, wherein the area in which the projected spots of fibers are provided in the surface of the pressure-sensitive adhesive layer is in a ratio of from 0.001 to 20% of all the surface area of the pressure-sensitive adhesive layer.

**8. (currently amended):** The pressure-sensitive adhesive tape or sheet as claimed in claim 1, wherein the length of the fibers ~~to constitute~~constituting the projected spots is from 0.1 to 5 mm.

**9. (currently amended):** The pressure-sensitive adhesive tape or sheet as claimed in claim 1, wherein the thickness of the fibers ~~to constitute~~constituting the projected spots is from 0.1 to 20 deniers.

**10. (original):** The pressure-sensitive adhesive tape or sheet as claimed in claim 1, which is for flooring material fixation.

**11. (withdrawn):** A method for producing the pressure-sensitive adhesive tape or sheet of claim 1, which comprises flocking the surface of the pressure-sensitive adhesive layer on at least one surface of the support to form projected spots of fibers partly in the surface of the pressure-sensitive adhesive layer.

**12. (withdrawn):** The method for producing the pressure-sensitive adhesive tape or sheet as claimed in claim 11, wherein a releasable liner having holes is put on the surface of the pressure-sensitive adhesive layer, and the surface of the pressure-sensitive adhesive layer is flocked in that condition to thereby form a projected spot of fibers in the sites of the surface of the pressure-sensitive adhesive layer corresponding to the holes of the releasable liner.

**13. (withdrawn):** A releasable substrate of which at least one surface is a release face relative to a pressure-sensitive adhesive face and has holes, wherein the peripheral region around the holes is thickened, as swelling toward the side of one face alone.

**14. (withdrawn):** The releasable substrate as claimed in claim 13, which is formed of a plastic substrate.

**15. (withdrawn):** The releasable substrate as claimed in claim 14, wherein the holes are formed through perforation.

**16. (withdrawn):** The releasable substrate as claimed in claim 15, wherein the temperature for perforation is lower than the melting point of the plastic substrate and not lower than a temperature of (melting point -30° C).

**17. (withdrawn):** The releasable substrate as claimed in claim 13, which is used in producing a pressure-sensitive adhesive tape or sheet that comprises a support, a pressure-sensitive adhesive layer formed on at least one surface of the support, and projected spots of fibers formed partly in the surface of the pressure-sensitive adhesive layer on at least one surface of the support.

**18. (withdrawn):** The releasable substrate as claimed in claim 17, wherein the holes are formed in the sites corresponding to the projected spots of fibers to be formed in the surface of the pressure-sensitive adhesive layer.

**19. (currently amended):** A pressure-sensitive adhesive tape or sheet ~~having a pressure-sensitive adhesive layer formed on at least one surface of the support thereof, and having projected spots of fibers formed partly in the surface of the pressure-sensitive adhesive layer on at least one surface of the support~~ according to claim 1, which is produced by the use of the releasable substrate of which at least one surface is a release face relative to a pressure-sensitive adhesive face and has holes, wherein the peripheral region around the holes is thickened, as swelling toward the side of one face alone ~~claim 13~~.

**20. (original):** The pressure-sensitive adhesive tape or sheet as claimed in claim 19, wherein the projected spots of fibers are raised spots of fibers that are raised from the surface of the pressure-sensitive adhesive layer.

**21. (original):** The pressure-sensitive adhesive tape or sheet as claimed in claim 19, wherein the projected spots of fibers of the surface of the pressure-sensitive adhesive layer are so designed that they have a predetermined pattern as a whole.

**22. (withdrawn):** A method for producing the pressure-sensitive adhesive tape or sheet of claim 19, which comprises putting the releasable substrate of claim 13 on a pressure-sensitive adhesive layer in such a manner that its flat face not having the swollen parts is in contact with the surface of the pressure-sensitive adhesive layer, and flocking the surface of the pressure-sensitive adhesive layer in that condition to thereby form projected spots of fibers in the sites of the surface of the pressure-sensitive adhesive layer corresponding to the holes of the releasable substrate.